

Discription

The HGBLC15C protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD. It gives designer the flexibility to protect one bi-directional

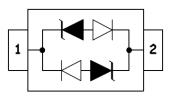
It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



SOD-323

Features

- ★ Transient protection for high-speed data lines IEC 61000-4-2(ESD) ±30kV (Contact) ±30kV (Air) IEC 61000-4-4(EFT) 40A (5/50 ns)
- ★ Peak power dissipation: 350W (8/20us)
- ★ Working voltages : 15V
- ★ Protects one Vcc or data line
- ★ Low clamping voltage
- ★ Low leakage current



Circuit Diagram

Orderingin formation

Product ID	Pack	Qty(PCS)
HGBLC15C	SOD-323	3000

Absolute Ratings(Tamb = 25°C)

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (t _P = 8/20 μ s)	350	W
T _L	Maximum lead temperature for soldering during 10s	260	°C
T_{stg}	Storage Temperature Range	-55 to +155	°C
T _{op}	Operating Temperature Range	-40 to +125	°C
T _j	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	±30 ±30	KV
	IEC61000-4-4 (EFT)	40	Α



Electrical Characteristics

Symbol	Parameter	Test Condition	Min Typ		Max	Units
V _{RWM}	Reverse Working Voltage				15	V
V _{BR}	Reverse Breakdown Voltage	I _τ = 1mA	16.7			V
IR	Reverse Leakage Current	V _{RWM} = 15V			1	μA
Vc	Clamping Voltage	$I_{RWM} = 1A, t_p = 8/20 \mu s$			24	V
		$I_{RWM} = 10A, t_P = 8/20 \mu s$			31.8	V
C	Junction Capacitance	V _R = 0V, f = 1MHz		1.0	1.2	pF

Typical Characteristics

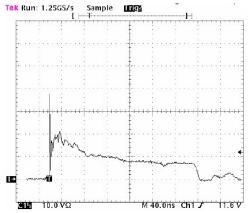
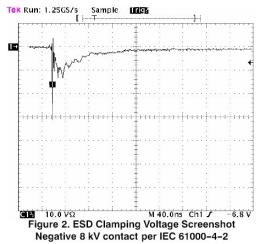
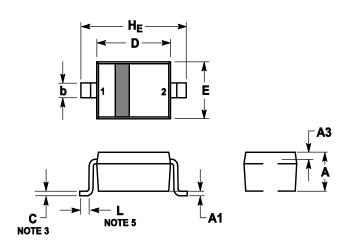


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV contact per IEC 61000-4-2



Outline And Dimensions

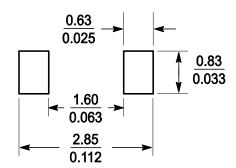


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.8	0.9	1	0.031	0.035	0.04
A1	0	0.05	0.1	0	0.002	0.004
A3	0.15REF		0.006REF		F	
b	0.25	0.32	0.4	0.01	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.6	1.7	1.8	0.062	0.066	0.07
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H _E	2.3	2.5	2.7	0.09	0.098	0.105

Soledering Footprint





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